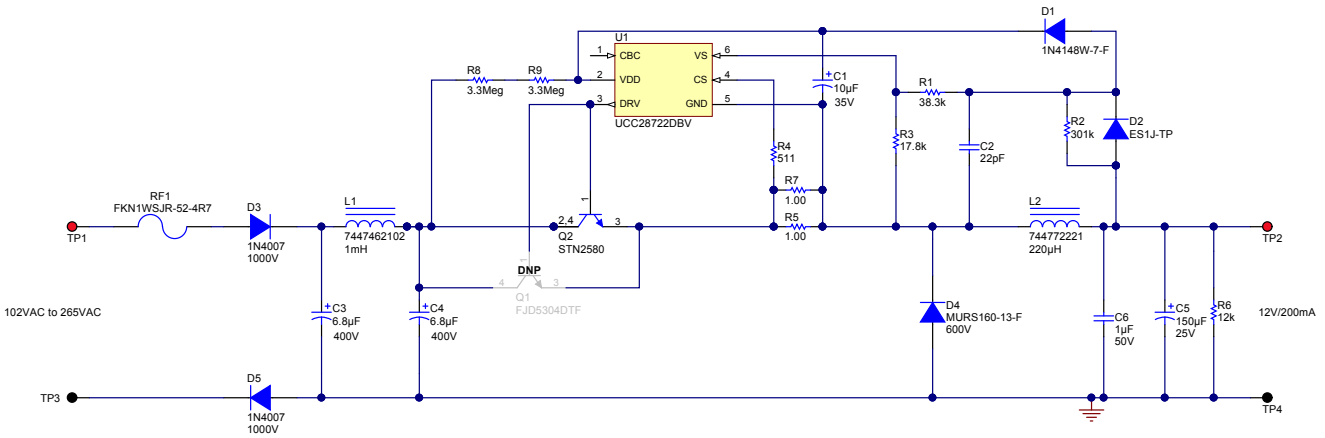
Notes:

1. To be able to continuously operate with input voltage as low as 85VAC, full wave rectifier or larger input capacitance will be needed.



PCB Number: PMP9707
PCB Rev: A

PCB
LOGO
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Designed for: Public Release		Mod. Date: 5/5/2015	
Project Title: UCC28722 High-side Buck Converter			
Number: PMP9707	Rev: A	Sheet Title: 85Vac- 265Vac to 12V/0.2A	
SVN Rev: Version control disabled		Assembly Variant: 001	Sheet: 1 of 2
Drawn By: S Yu		File: PMP9707_01.SchDoc	Size: B
Engineer: Enter name of project lead		Contact: http://www.ti.com/support	

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